XF-6 IC Test Handler





XF-6 IC Test handler is simple, low cost. Supports most leaded package including SOP and PDIP etc.

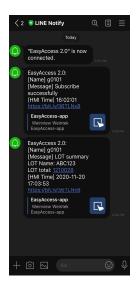
Supports HV insolation test sites and is ideal for Hipot and PD test applications.



Integrated with Hipot tester

Ready for industry 4.0

- Production data logging
- Supports database
- Message/Email alerts
- Remote assistance
- Barcode supported



Handler pushes alert to smart phone



System configuration

- ☐ Two test sites
- ☐ Test sites options
 - Plunger to Board
 - Clamping contact
- ☐ Ambient only temperature
- ☐ Tube in and Tube out
- ☐ Touch screen HMI

Device Handling

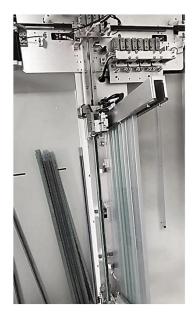
- ☐ Two Tracks, One site per track
- ☐ Auto tube loader
- ☐ Auto tube unloader
 - 1 auto for pass bin
 - 4 manual reject bins
- ☐ Ceramic lead backers (PTB)
- ☐ Device contactor
 - Kelvin
 - Non-Kelvin
 - Third party



Touch Screen GUI



Tube Loader



Tube unloader



XF-6 System Specifications

Applications	
Package Types	SOIC, SSOP, TSSOP, PDIP
Package Sizes	SO 118mil to 300mil
Leads	8 to 28 leads
Test Sites	Two
Temperature	Ambient only
Contactors	

Contactors	
Socket Type	KelvinNon-KelvinThird party
Finger Type	KelvinNon-KelvinThird party
Site pitch	60mm

System Dimension		
Weight	250Kg	
Height	1700mm	
Footprint	900 x 900mm	

Input/Output	
Input	Tube Auto Loader
Output	Bin1 Tube Auto UnloaderReject bins Manual Tube output
Throughput	Up to 9000 UPH
Index Time	750ms per site

Tester Interface		
Interface	 TTL RS-232 serial (optional) IEEE-488 GPIB (optional) 	
Test Modes	Parallel/SynchronousAsynchronousAlternating/PingPong	

User Interface	
Display	Touch screen GUI

Facility requirement	
Electrical	220VAC Single phase 50/60Hz
Air supply	CDA 0.5MPa

